



ON Semiconductor®

FDD6685

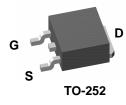
30V P-Channel PowerTrench^o MOSFET

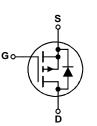
General Description

This P-Channel MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 25V).

Features

- -40 A, -30 V. $R_{DS(ON)} = 20 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 30 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Qualified to AEC Q101





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-30	V
V _{GSS}	Gate-Source Voltage		±25	V
I _D	Continuous Drain Current @Tc=25°C	(Note 3)	-40	
	@T _A =25°C	(Note 1a)	-11	A
	Pulsed, PW ≤ 100	0µS (Note 1b)	-100	
PD	Power Dissipation for Single Operation	(Note 1)	52	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at http://www.aecouncil.com/

All ON Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

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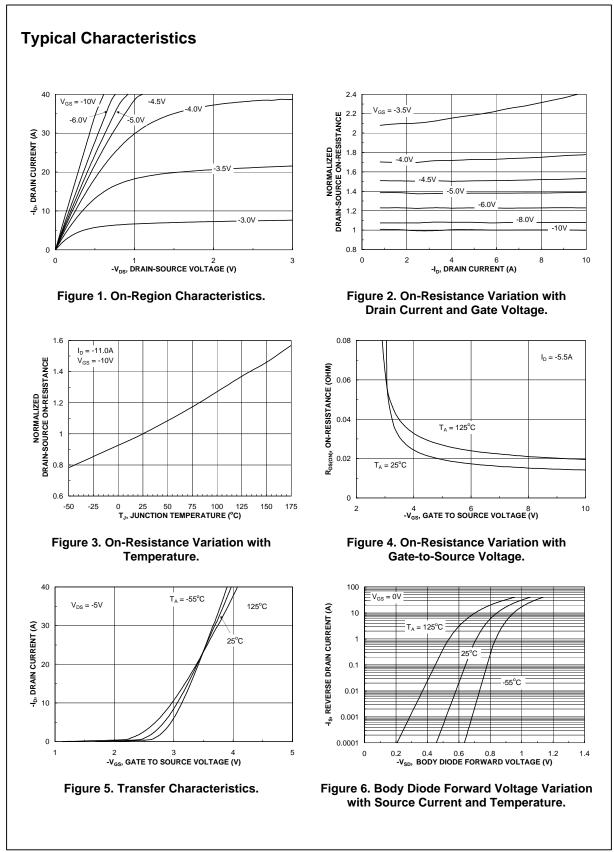
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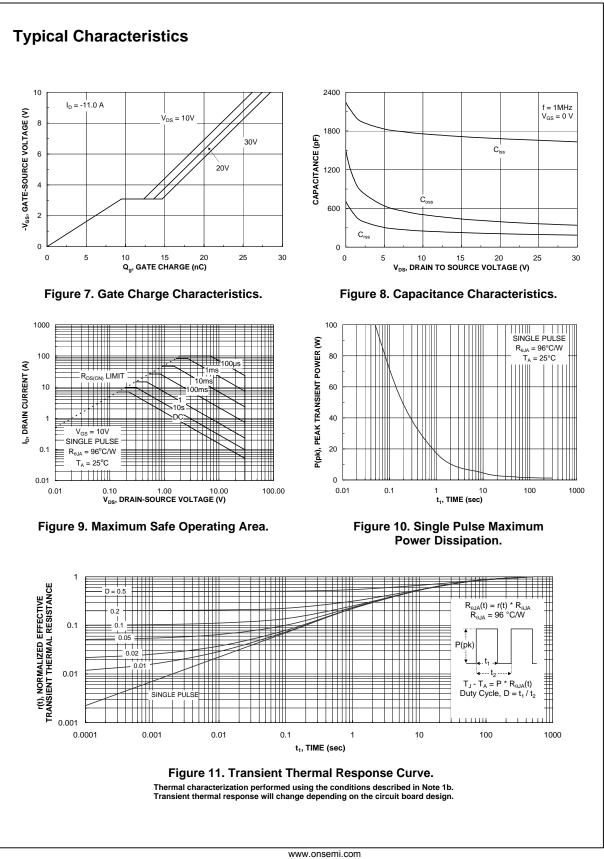
Device Marking Device		Reel Size Tape Wi		dth Quantity			ity	
FDD	6685	FDD6685	13"	13" 16mm		n 2500 units		
Electric	al Char	acteristics	$T_{\Delta} = 25^{\circ}C$ unless otherwise	noted				
Symbol		Parameter	Test Condi		Min	Тур	Max	Units
Drain-So	urce Aval	anche Ratings (Note	e 4)					
E _{AS}		se Drain-Source	$I_{\rm D} = -11 \text{ A}$			42		mJ
AS	Maximum Avalanche	Drain-Source Current				-11		A
Off Chara	acteristics	5						
BV _{DSS}	Drain-Sou	rce Breakdown Voltage	$V_{GS} = 0 V, I_D = -250$	μA	-30			V
<u>ΔBVdss</u> ΔTj	Breakdowr Coefficient	N Voltage Temperature	$I_D = -250 \ \mu A$, Refere			-24		mV/°C
DSS	Zero Gate	Voltage Drain Current	$V_{DS} = -24 \text{ V}, V_{GS} =$				-1	μA
GSS	Gate-Body	/ Leakage	$V_{GS} = \pm 25V$, $V_{DS} =$	0 V			±100	nA
On Chara	acteristics	5 (Note 2)						
V _{GS(th)}	Gate Three	shold Voltage	$V_{DS} = V_{GS}, I_D = -250$	μA	-1	-1.8	-3	V
$\Delta V_{GS(th)} \Delta T_J$		shold Voltage re Coefficient	$I_D = -250 \ \mu A$, Refere	nced to 25°C		5		mV/°C
R _{DS(on)}	Static Drai On–Resist		$ \begin{array}{ll} V_{GS} = -10 \ V, & I_D = \\ V_{GS} = -4.5 \ V, & I_D = \\ V_{GS} = -10 \ V, I_D = -11 \end{array} $	–9 A		14 21 20	20 30	mΩ
D(on)	On-State I	Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS}$		-20			А
g fs	Forward Tr	ansconductance	$V_{DS} = -5 V$, $I_D =$	–11 A		26		S
Dynamic	Characte	eristics						
Ciss	Input Capa		$V_{DS} = -15 V$, V_{GS}	= 0 V,		1715		pF
Coss	Output Ca	pacitance	f = 1.0 MHz 440			pF		
C _{rss}	Reverse T	ransfer Capacitance	-			225		pF
R _G	Gate Resis	stance	V_{GS} = 15 mV, f =	1.0 MHz		3.6		Ω
Switchin	a Charact	eristics (Note 2)						
d(on)	Turn–On D	, ,	$V_{DD} = -15 V$, $I_D =$	–1 A,		17	31	ns
t _r	Turn–On R	Rise Time	$V_{GS} = -10 V$, R_{GE}			11	21	ns
d(off)	Turn–Off D	elay Time	-			43	68	ns
f	Turn–Off F	all Time				21	34	ns
Qg	Total Gate	Charge	$V_{DS} = -15V$, $I_D =$	–11 A,		17	24	nC
Q _{gs}	Gate-Sour	ce Charge	$V_{GS} = -5 V$			9		nC
Q_{gd}	Gate-Drain	n Charge				4		nC
Drain-Sc	ource Dio	de Characteristics	and Maximum Ra	atings				
V _{SD}		rce Diode Forward	$V_{GS} = 0 V, I_{S} = -3.2$			-0.8	-1.2	V
Trr		erse Recovery Time	IF = -11 A,			26		ns
Qrr	Diode Rev	erse Recovery Charge	diF/dt = 100 A/µs			13		nC

	ristics	$T_A = 25^{\circ}C$ unless otherwise noted
Notes:		
$R_{\theta,JA}$ is the sum of the junction-to-case	and case-to-	ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of
the drain pins. $R_{\theta,JC}$ is guaranteed by	design while F	$R_{\theta CA}$ is determined by the user's board design.
-	a) F	b) R _{BJA} = 40°C/W when mounted on a b) R _{BJA} = 96°C/W when mounted on a minimum pad.
-	1	in ² pad of 2 oz copper on a minimum pad.
cale 1 : 1 on letter size paper		
Pulse Test: Pulse Width < 300µs, Dut	y Cycle < 2.0%	6
Maximum current is calculated as:	$\sqrt{R_{DS(ON)}}$	where P_D is maximum power dissipation at T_C = 25°C and $R_{DS(on)}$ is at $T_{J(max)}$ and V_{GS} = 10V.
Starting $T_J = 25^{\circ}C$, L = 0.69mH, $I_{AS} =$	–11A	

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